# imall

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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(on)</sub>	Ι <sub>D</sub> T <sub>A</sub> = +25°C
20V	$3.0\Omega @ V_{GS} = 4.5V$	240mA
200	6.0Ω @ V <sub>GS</sub> = 1.8V	180mA

#### Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

#### **Applications**

- DC-DC Converters
- Power Management Functions

#### Features and Benefits

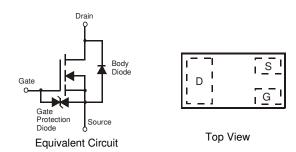
- N-Channel MOSFET
- Low On-Resistance
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package, 0.4mm Maximum Package Height

N-CHANNEL ENHANCEMENT MODE MOSFET

- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.001 grams (Approximate)



#### Ordering Information (Note 4)

ESD PROTECTED

Part Number	Case	Packaging
DMN26D0UFB4-7	X2-DFN1006-3	3,000/Tape & Reel
DMN26D0UFB4-7B	X2-DFN1006-3	10,000/Tape & Reel

Notes:

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### X2-DFN1006-3

**Bottom View** 



#### **Marking Information**

DMN26D0UFB4-7	From date code 1527 (YYWW), this changes to: Top View Dot Denotes Drain Side Top View Bar Denotes Gate and Source Side
DMN26D0UFB4-7B	Top View Bar Denotes Gate and Source Side M1 = Part Marking Code

#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain Source Voltage			V <sub>DSS</sub>	20	V
Gate-Source Voltage			V <sub>GSS</sub>	±10	V
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	240 190	mA
Continuous Drain Current (Note 5) V <sub>GS</sub> = 1.8V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	180 140	mA
Pulsed Drain Current - $T_P = 10\mu s$			I <sub>DM</sub>	805	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5) $@T_A = +25^{\circ}C$	PD	350	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Note: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

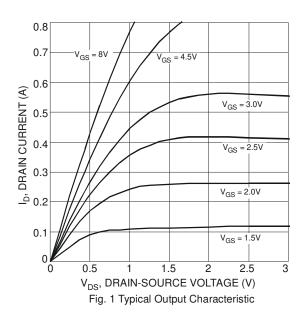


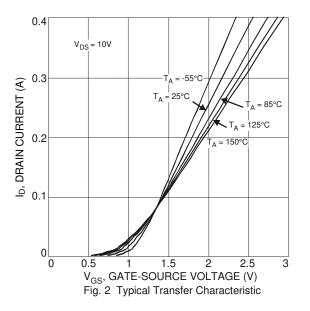
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)			•	•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20			V	$V_{GS} = 0V, I_D = 100 \mu A$	
Zero Gate Voltage Drain Current @ $T_{C}$ = +25°C	IDSS	_		500	nA	$V_{DS}=20V,\ V_{GS}=0V$	
Gate-Body Leakage	I <sub>GSS</sub>		_	±1 ±100	μA nA	$V_{GS} = \pm 10V, V_{DS} = 0V$ $V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.6		0.9	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		1.8 2.5 3.4 4.7	3.0 4.0 6.0 10.0	Ω	$\begin{array}{l} V_{GS} = 4.5V, \ I_{D} = 100mA \\ V_{GS} = 2.5V, \ I_{D} = 50mA \\ V_{GS} = 1.8V, \ I_{D} = 20mA \\ V_{GS} = 1.5V, \ I_{D} = 10mA \end{array}$	
Forward Transconductance	Y <sub>fs</sub>	180	242		mS	$V_{DS} = 10V, I_{D} = 0.1A$	
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	0.5	_	1.4	V	$V_{GS} = 0V, I_{S} = 115mA$	
DYNAMIC CHARACTERISTICS (Note 7)	DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	—	14.1	28.2	pF		
Output Capacitance	Coss	—	2.9	5.8	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	1.6	3.2	pF		
SWITCHING CHARACTERISTICS (Note 7)							
Turn-On Delay Time	t <sub>D(ON)</sub>	—	3.8				
Rise Time	t <sub>R</sub>	_	7.9	—	ns	$V_{GS} = 4.5V, V_{DD} = 10V$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	13.4	—	113	$I_D = 200 mA, R_G = 2.0 \Omega$	
Fall Time	t <sub>F</sub>		15.2				

Notes:

6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing.









1

150°C

T<sub>A</sub> = 85°C

T<sub>A</sub> = 25°C

 $T_A = -55^{\circ}C$ 

75

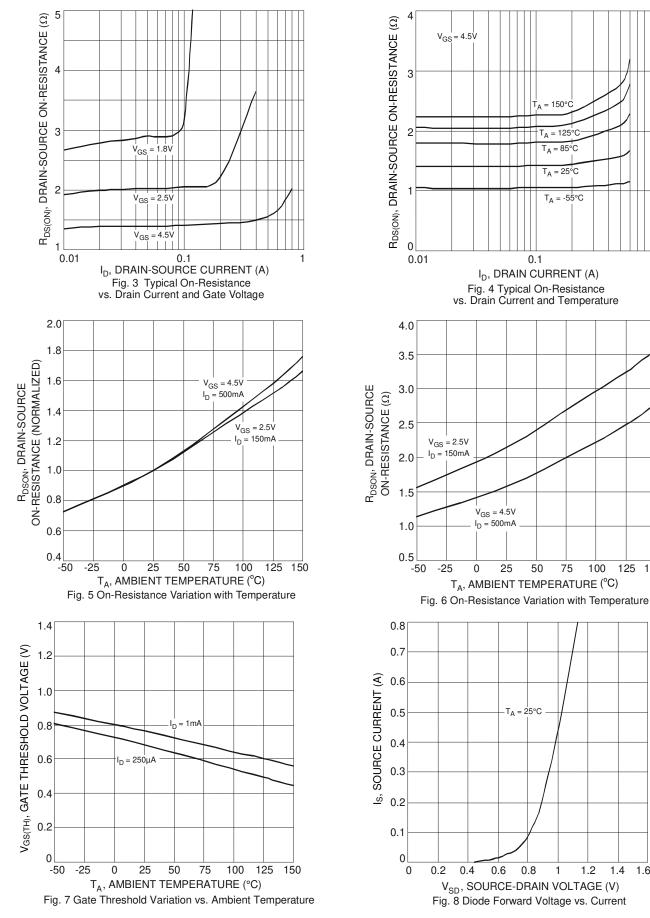
100

1.2

1

1.4 1.6

125 150

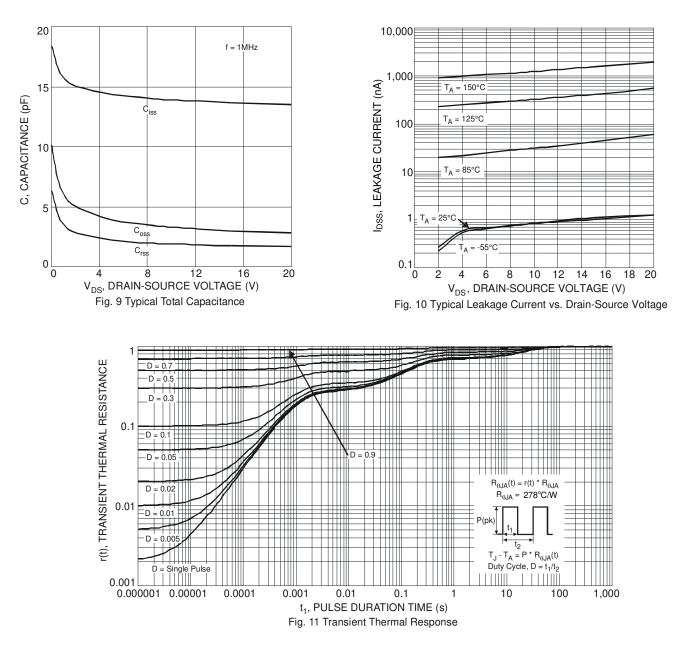


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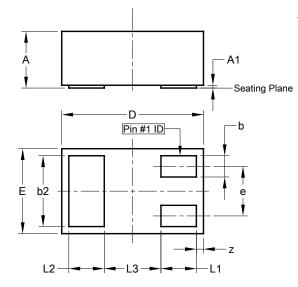






#### **Package Outline Dimensions**

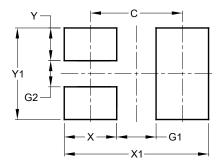
Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1006-3					
Dim	Min	Max	Тур		
Α		0.40			
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
е	1	-	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	-	-	0.40		
z	0.02	0.08	0.05		
All D	All Dimensions in mm				

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



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